

HAT2170H Silicon N Channel MOS FET

Power Switching

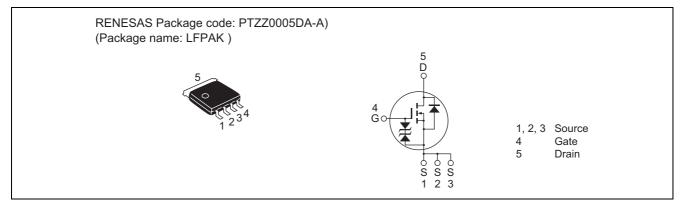
REJ03G0121-0500 Rev.5.00 Sep 26, 2005

Features

- High speed switching
- Capable of 7 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 3.3 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	40	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	Ι _D	45	A
Drain peak current	Note1 I _{D(pulse)}	180	A
Body-drain diode reverse drain current	I _{DR}	45	A
Avalanche current	I _{AP} ^{Note2}	30	A
Avalanche energy	E _{AR} ^{Note2}	72	mJ
Channel dissipation	Pch ^{Note3}	30	W
Channel to Case Thermal Resistance	θch-C	4.17	°C/W
Channel temperature	Tch	150	٥°
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. Value at Tch = 25°C, Rg \ge 50 Ω

3. $Tc = 25^{\circ}C$



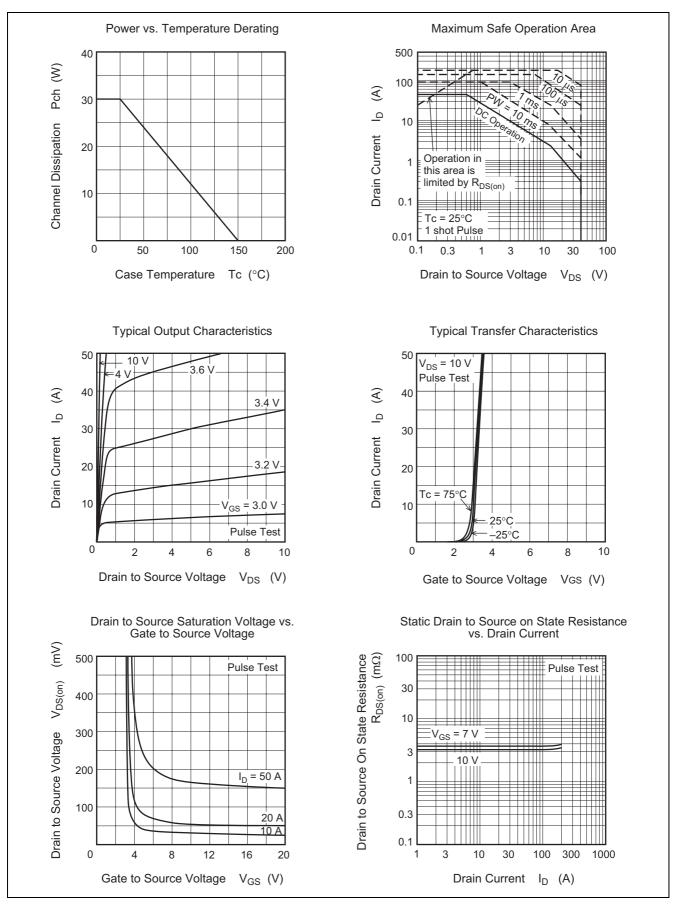
Electrical Characteristics

ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	40	_	—	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}		_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}		_	1	μΑ	$V_{DS} = 40 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.5	_	3.0	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}		3.3	4.2	mΩ	$I_D = 22.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}		3.7	5.0	mΩ	$I_D = 22.5 \text{ A}, V_{GS} = 7 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	39	65	_	S	$I_D = 22.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss		4650	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$ f = 1 MHz
Output capacitance	Coss		900	_	pF	
Reverse transfer capacitance	Crss		285	_	pF	
Gate Resistance	Rg		0.5	_	Ω	
Total gate charge	Qg		62	_	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V},$ $I_D = 45 \text{ A}$
Gate to source charge	Qgs		18	_	nC	
Gate to drain charge	Qgd		7.0	_	nC	
Turn-on delay time	t _{d(on)}		15	_	ns	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \ V, \ I_D = 22.5 \ A, \\ V_{DD} \cong 10 \ V, \ R_L = 0.44 \ \Omega, \\ Rg = 4.7 \ \Omega \end{array}$
Rise time	tr		43	_	ns	
Turn-off delay time	t _{d(off)}		44	_	ns	
Fall time	t _f	_	7.1		ns	
Body-drain diode forward voltage	V _{DF}	_	0.84	1.1	V	$IF = 45 A, V_{GS} = 0^{Note4}$
Body–drain diode reverse recovery time	t _{rr}	_	40	—	ns	IF = 45 A, V _{GS} = 0, di _F / dt = 100 A/ μs

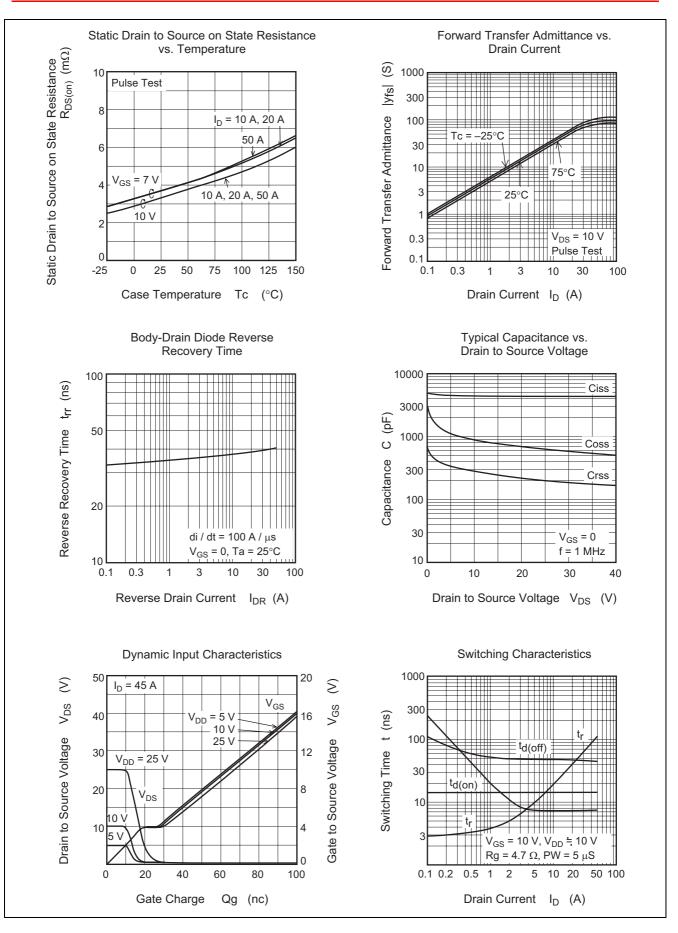
Notes: 4. Pulse test



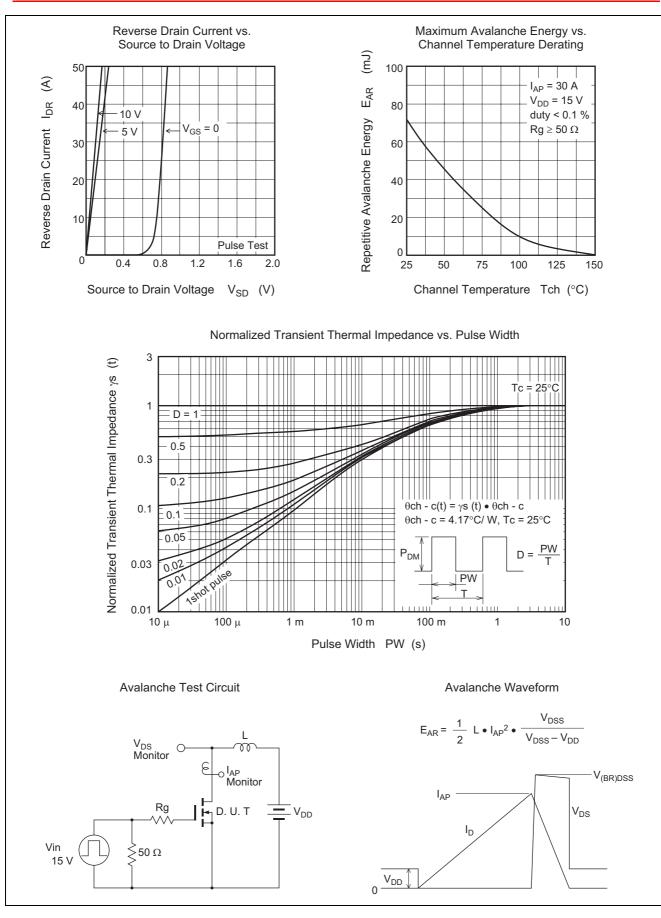
Main Characteristics



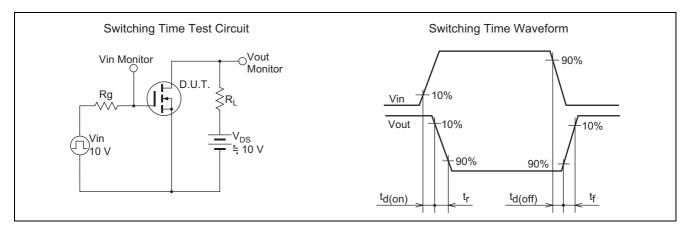






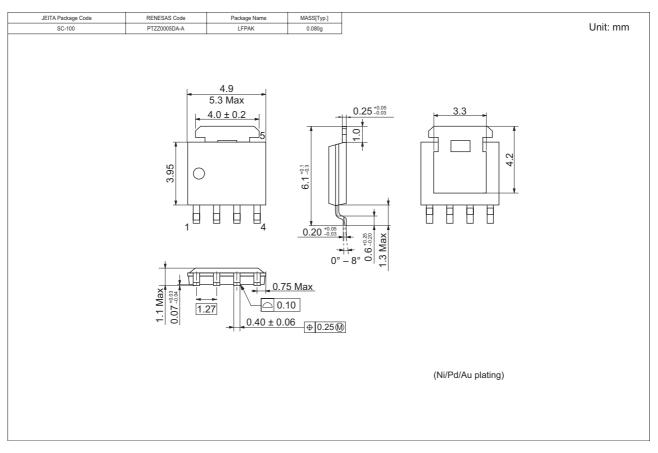








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container	
HAT2170H-EL-E	2500 pcs.	Emboss Taping	

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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